

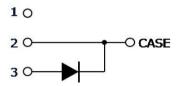
# CoolSiC™ Automotive Schottky Diode 650V G5

## 650V/40A Silicon Carbide Schottky Diode in TO247-3

#### **Features**

- Revolutionary semiconductor material Silicon Carbide
- Benchmark switching behavior
- No reverse recovery/ No forward recovery
- Temperature independent switching behavior
- High surge current capability
- Pb-free lead plating; RoHS compliant
- Junction Temperature range from -40°C to 175°C
- System efficiency improvement over Si diodes
- System cost / size savings due to reduced cooling requirements
- Enabling higher frequency / increased power density solutions
- Higher system reliability due to lower operating temperatures
- Reduced EMI





### **Potential Applications**

- Traction inverter
- Booster / DCDC Converter
- On board Charger / PFC









### **Product Validation**

"Qualified for Automotive Applications. Product Validation according to AEC-Q100/101"

### Description

The 5th Generation CoolSiC<sup>TM</sup> Automotive Schottky Diode represents Infineon leading edge technology for Silicon Carbide Schottky Barrier diodes. Thanks to a compact design and a technology based on thin wafers, this family of products shows improved efficiency over all load conditions resulting from both its thermal characteristics and low figure of merit (Qc x Vf). This product family has been designed to complement Infineon's IGBT and CoolMOS<sup>TM</sup> portfolio. This ensures meeting the most stringent application requirements in the 650V voltage class.

Product Information				
Ordering Code AIDW40S65				
Marking	AD4065C5			
Package	PG-TO247-3-41			
SP Number	SP001725204			

Parameter	Value/Unit
$V_{DC,max}$	650 V
I <sub>F</sub> ; T <sub>C</sub> < 117 °C	40 A
$Q_{C}$ ; $V_{R}$ = 400 V	56 nC
E <sub>C</sub> ; V <sub>R</sub> = 400 V	12.9 μJ
$T_{j,max}$	175 °C

Pin	Definition
Pin 2, case	Cathode
Pin 3	Anode



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## **Maximum Ratings**

# 1 Maximum Ratings

## Table 1 Maximum ratings<sup>1</sup>

Parameter	Symbol	Value	Unit
Repetitive peak reverse voltage	$V_{RRM}$	650	V
Continuous forward current for $R_{thJC,max}$ $T_C = 117  ^{\circ}C$ , D=1	I <sub>F</sub>	40	А
Surge non-repetitive forward current, sine halfwave $T_{C}=25^{\circ}\text{C},t_{p}=10\text{ms}$ $T_{C}=150^{\circ}\text{C},t_{p}=10\text{ms}$	I <sub>F,SM</sub>	182 153	А
Non-repetitive peak forward current $T_C=25^{\circ}C$ , $t_p=10\mu s$	I <sub>F,max</sub>	1432	А
$i^2t$ value $T_C=25^{\circ}C, t_p=10ms$ $T_C=150^{\circ}C, t_p=10ms$	∫i² dt	166 118	A <sup>2</sup> s
Diode dv/dt ruggedness V <sub>R</sub> =0480V	dv/dt	100	V/ns
Power dissipation T <sub>C</sub> = 25°C	P <sub>tot</sub>	183	W
Operating temperature	T <sub>j</sub>	-40175	°C
Storage temperature	T <sub>stg</sub>	-55150	°C
ESD Human body model, R= 1.5 k $\Omega$ , C = 100 pF Charged device model		8	kV
Soldering temperature, wavesoldering only allowed at leads, 1.6mm (0.063 in.) from case for 10 s	T <sub>sold</sub>	260	°C
Mounting Torque (M3 and M4 screws)		70	Ncm



**Thermal Characteristics** 

## 2 Thermal Characteristics

## Table 2 Thermal Characteristics<sup>1</sup>

Daramatar	Symbol	Values			l lmit	Note/Test condition
Parameter		Min.	Тур.	Мах.	Unit	Note/Test condition
Thermal resistance, junction–case <sup>2</sup>	$R_{thJC}$	-	0.6	0.8	K/W	
Thermal resistance, junction-ambient <sup>2</sup>	R <sub>thJA</sub>	-	-	62	K/W	



#### **Electrical Characteristics**

## 3 Electrical Characteristics

#### Table 3 Static Characteristics

Devementor	Symbol	Values			l lmit	Note/Test on dition
Parameter		Min.	Тур.	Мах.	Unit	Note/Test condition
DC blocking voltage	V <sub>DC</sub>	650	-	-		$T_j = 25$ °C, $I_R = 0.12$ mA
Diode forward voltage <sup>3</sup>	V <sub>F</sub>	-	1.5	1.7	V	T <sub>j</sub> = 25°C, I <sub>F</sub> = 40 A
		-	1.8	2.1		$T_j = 150$ °C, $I_F = 40$ A
Reverse current	I <sub>R</sub>	-	7	120		V <sub>R</sub> = 650 V, T <sub>j</sub> = 25 °C
		-	47	-	μΑ	V <sub>R</sub> = 650 V, T <sub>j</sub> = 150 °C

Table 4 Dynamic Characteristics at Tj=25°C unless noted otherwise

Parameter	Symbol	Values			Unit	Note/Test condition
Parameter		Min.	Тур.	Мах.	Ullit	Note/Test condition
Total capacitive charge	Q <sub>c</sub>	-	56	-	nC	$V_R = 400 \text{ V}, \text{ di/dt} = 200 \text{ A/}\mu\text{s},$ $I_F \le I_{F,MAX}, T_j = 150 \text{ °C}$
Total capacitance	С	-	1138	-	pF	V <sub>R</sub> = 1 V, f = 1 MHz
		-	148	-		V <sub>R</sub> = 300 V, f = 1 MHz
		-	145	-		V <sub>R</sub> = 600 V, f= 1 MHz

#### Footnotes:

<sup>&</sup>lt;sup>1</sup> The parameter is not subject to production test- verified by design/characterization.

<sup>&</sup>lt;sup>2</sup> Rth,JC defined as per JESD-51-14. Rth,JA defined as per JESD-51-2.

<sup>&</sup>lt;sup>3</sup> Only the value at 25°C is subject to production test. The value at 150°C is only verified by design/characterization.



**Electrical Characteristics Diagrams** 

## 4 Electrical Characteristics Diagrams

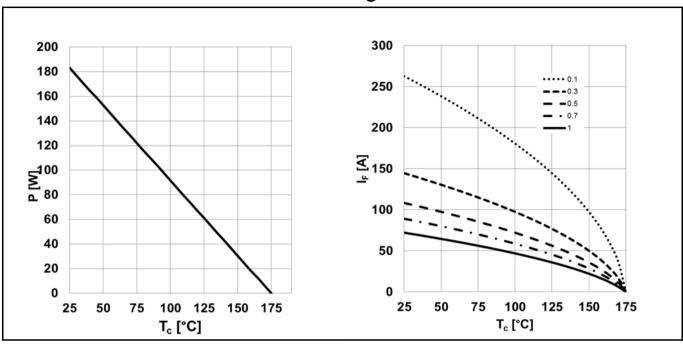


Figure 1 (LEFT) Power dissipation;  $P_{tot} = f(T_C)$ ;  $R_{thJC,max}$  (RIGHT) Diode forward current;  $I_F = f(T_C)$ ;  $T_i \le 175$  °C;  $R_{thJC,max}$ ; parameter: D=duty cycle

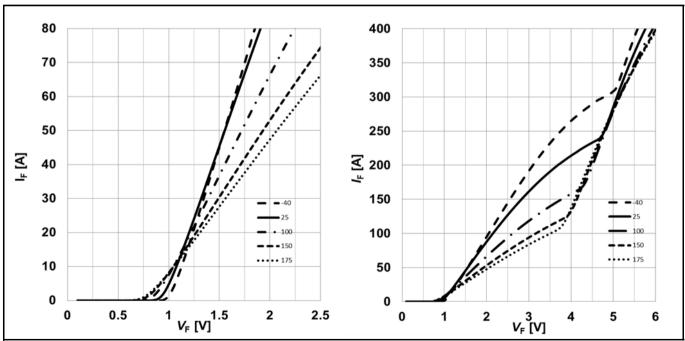


Figure 2 (LEFT) Typical forward characteristic;  $I_F = f(V_F)$ ;  $t_P = 200 \,\mu s$ ; parameter: $T_j$  (RIGHT) Typical forward characteristics in surge current;  $I_F = f(V_F)$ ;  $t_P = 200 \,\mu s$ ; parameter: $T_j$ 



#### **Electrical Characteristics Diagrams**

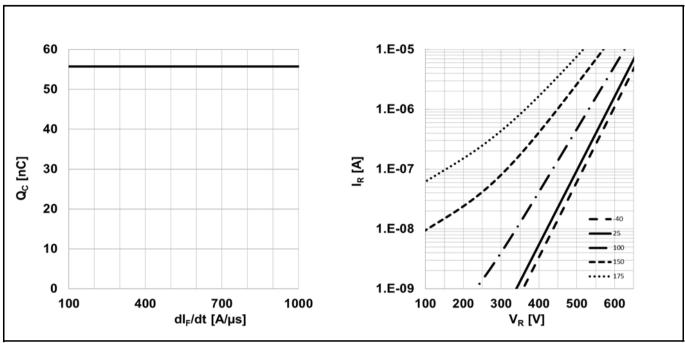


Figure 3 (LEFT) Typical capacitive charge versus current slope (only capacitive charge, guaranteed by design);  $Q_C = f(di_F/dt)$ ;  $T_j = 150^{\circ}C$ ;  $V_R = 400V$ ;  $I_F \le I_{F,max}$  (RIGHT) Typical reverse current versus reverse voltage;  $I_R = f(V_R)$ ; parameter:  $T_i$ 

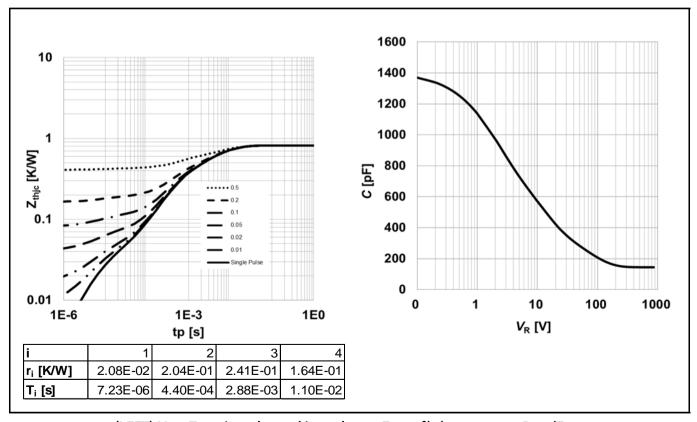


Figure 4 (LEFT) Max. Transient thermal impedance;  $Z_{thJC} = f(t_p)$ ; parameter:  $D = t_p/T$  (RIGHT) Typ. Capacitance vs. Reverse voltage;  $C = f(V_R)$ ;  $T_i = 25^{\circ}C$ ; f = 1 MHz



### **Electrical Characteristics Diagrams**

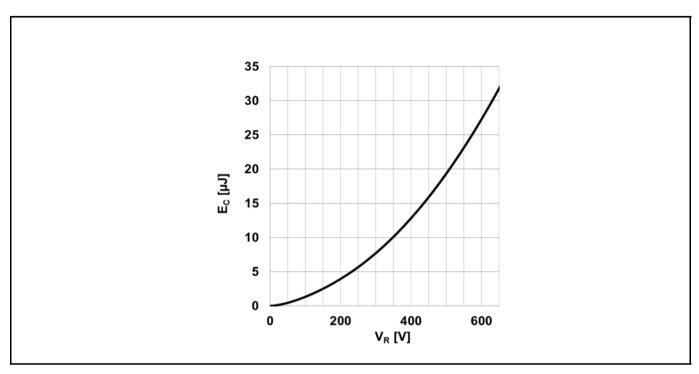


Figure 5 Typical capacitance stored energy;  $E_C = f(V_R)$ 

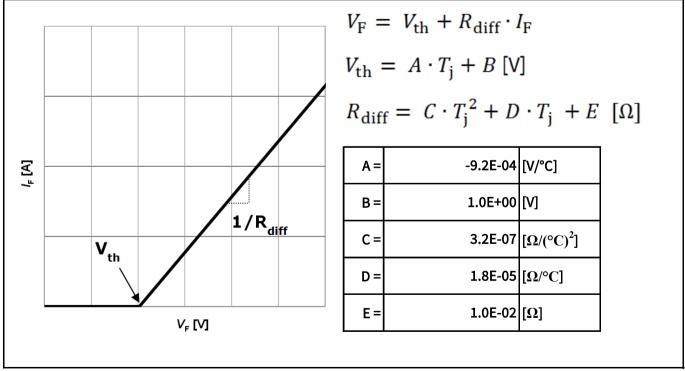


Figure 6 Simplified forward characteristics model  $V_F = f(I_F)$ ; -40°C <  $T_i$  <175°C;  $I_F$  < 80 A



**Package Outlines** 

## 5 Package Outlines

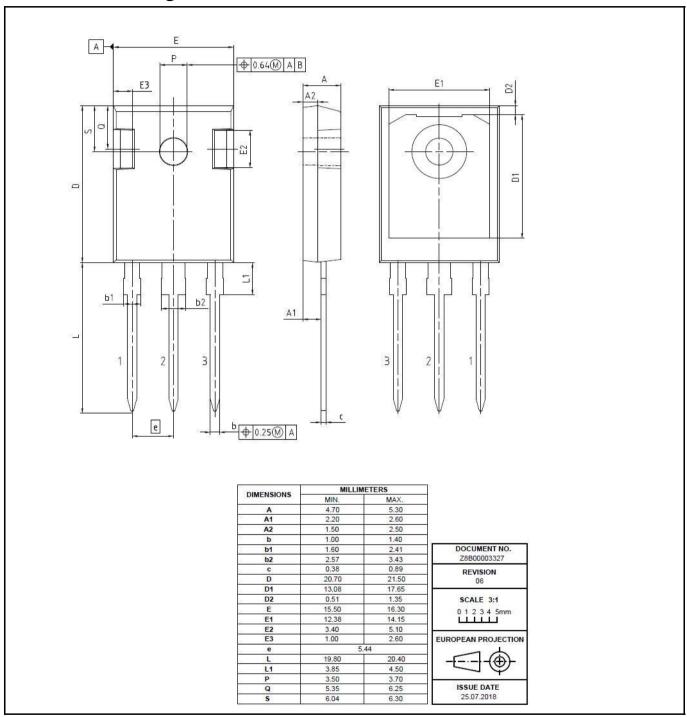


Figure 6 Package outline of PG-TO247-3-41 leaded (Dimensions in mm)



**Revision History** 

## **Revision History**

Document Version	Date of Release	Description of changes			
V3.0	26.11.2018	1st release of Data Sheet			



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